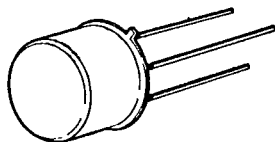
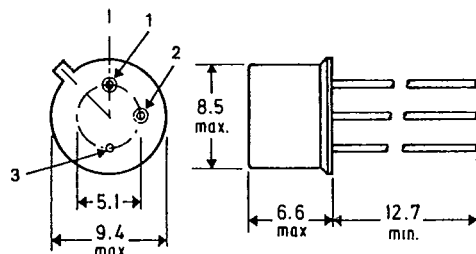


SEMELAB
2N 6801
2N 6802
MECHANICAL DATA

Dimensions in mm

MOS POWER**N-Channel Enhancement Mode****APPLICATIONS**

- FAST SWITCHING
- MOTOR CONTROLS
- POWER SUPPLIES

PIN 1—Source PIN 2—Gate PIN 3 Drain and Case

T039

ABSOLUTE MAXIMUM RATINGS ($T_{CASE} = 25^{\circ}\text{C}$ unless otherwise specified)

Parameter		2N 6801	2N 6802
V_{DS}	Drain source voltage	450V	500V
V_{DGR}	Drain gate voltage ($R_{GS} = 1\text{ M}\Omega$)	450V	500V
$I_D @ T_c = 25^{\circ}\text{C}$	Continuous drain current	$\pm 2.5\text{A}$	
$I_D @ T_c = 100^{\circ}\text{C}$	Continuous drain current	$\pm 1.5\text{A}$	
I_{DM}	Pulsed drain current (i)	$\pm 5\text{A}$	
V_{GS}	Gate-source voltage	$\pm 40\text{V}$	
$P_D @ T_c = 25^{\circ}\text{C}$	Maximum power dissipation	25W	
$P_D @ T_c = 100^{\circ}\text{C}$	Maximum power dissipation	10W	
Junction to case	Linear derating factor	0.2 W/ $^{\circ}\text{C}$	
Junction to ambient	Linear derating factor	0.005 W/ $^{\circ}\text{C}$	
T_j	Operating and	-55 to 150 $^{\circ}\text{C}$	
T_{stg}	storage temperature range		
Lead temperature	(1/16" from case for 10 secs.)	300 $^{\circ}\text{C}$	

(i) Pulse test: Pulse width $\leq 300\mu\text{sec}$, duty cycle $\leq 2\%$

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EDITOR *1/11-88*

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2N 6801 2N 6802

SEMELAB**ELECTRICAL CHARACTERISTICS (T_{case} = 25°C unless otherwise specified)****STATIC**

Parameter	Type	Min.	Typ.	Max.	Units	Test Conditions
BV _{DSS} Drain-Source Breakdown Voltage	2N6801	450*			V	V _{GS} = 0 I _D = 1.0 mA
	2N6802	500*			V	
V _{GS(th)} Gate-Threshold Voltage	All	2.0*		4.0*	V	V _{DS} = V _{GS} , I _D = 1.0 mA
I _{GSSF} Gate-Body Leakage Forward	All			100*	nA	V _{GS} = 20V
I _{GSSR} Gate-Body Leakage Reverse	All			-100	nA	V _{GS} = -20V
I _{DSS} Zero Gate Voltage Drain Current	All			1*	mA	V _{DS} = Max. Rating, V _{GS} = 0
	All			4.0*	mA	V _{DS} = Max. Rating, V _{GS} = 0 T _C = 125°C
I _{D(on)} On-State Drain Current ¹	2N6801	2.5			A	V _{DS} ≥ 2 V _{DS(ON)} , I _D = 1.5A
	2N6802	2.5			A	V _{DS} ≥ 2 V _{DS(ON)} , I _D = 1.5A
V _{DS(on)} Static Drain-Source On-State Voltage ¹	2N6801			3.75*	V	V _{GS} = 10V, I _D = 2.5A
	2N6802			3.75*	V	V _{GS} = 10V, I _D = 2.5A
R _{DS(on)} Static Drain-Source On-State Resistance ¹	2N6801			1.5*	Ω	V _{GS} = 10V, I _D = 1.5A
	2N6802			1.5*	Ω	V _{GS} = 10V, I _D = 1.5A
R _{DS(on)} Static Drain-Source On-State Resistance ¹	2N6801			3.5*	Ω	V _{GS} = 10V, I _D = 1.5A, T _C = 125°C
	2N6802			3.5*	Ω	V _{GS} = 10V, I _D = 1.5A, T _C = 125°C

DYNAMIC

g _{fs} Forward Transconductance ¹	All	1.5*		4.5*	S (U)	V _{DS} ≥ 2 V _{DS(ON)} , I _D = 1.5A
C _{iss} Input Capacitance	All	350*		900*	pF	V _{GS} = 0, V _{DS} = 25V f = 1 MHz
C _{oss} Output Capacitance	All	25*		200*	pF	
C _{rss} Reverse Transfer Capacitance	All	15*		60*	pF	
t _{d(on)} Turn-On Delay Time	All			30*	ns	V _{DD} = 225V, I _D = 1.5A R _g = 7.5Ω, R _L = 150Ω (MOS FET switching times are essentially independent of operating temperature.)
t _r Rise Time	All			30*	ns	
t _{d(off)} Turn-Off Delay Time	All			55*	ns	
t _f Fall Time	All			30*	ns	

THERMAL RESISTANCE

R _{thJC} Junction-to-Case	All			5.0*	°C/W	
R _{thJA} Junction-to-Ambient	All			170	°C/W	Free Air Operation

BODY-DRAIN DIODE RATINGS AND CHARACTERISTICS

I _S Continuous Source Current (Body Diode)	2N6801			-5	A	Modified MOS POWER symbol showing the integral P-N junction rectifier. 
	2N6802			-5	A	
I _{SM} Source Current ¹ (Body Diode)	2N6801			-2.5	A	
	2N6802			-2.5	A	
V _{SD} Diode Forward Voltage ¹	2N6801	-0.7		-1.4*	V	T _C = 25°C, I _S = -2.5A, V _{GS} = 0
	2N6802	-0.7		-1.4*	V	T _C = 25°C, I _S = -2.5A, V _{GS} = 0
t _{rr} Reverse Recovery Time	All		400		ns	T _J = 150°C, I _F = I _S , dI _F /ds = 100 A/μs

¹ Pulse Test: Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%**SEMELAB LTD., COVENTRY ROAD, LUTTERWORTH, LEICS. LE17 4JB**